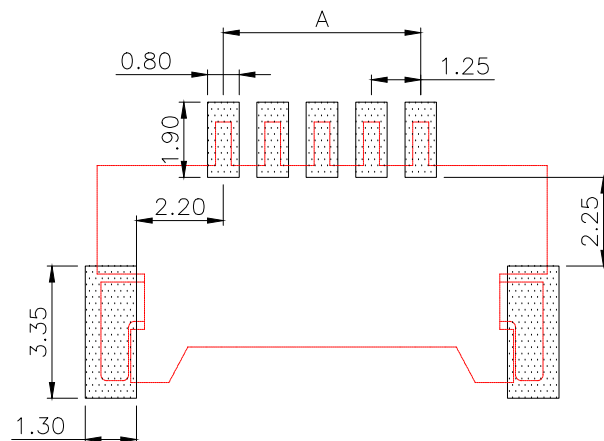
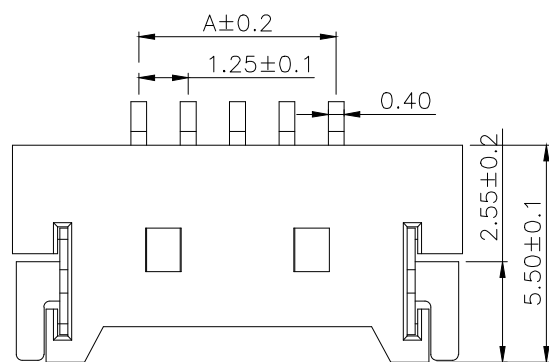
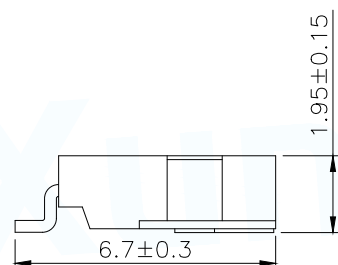
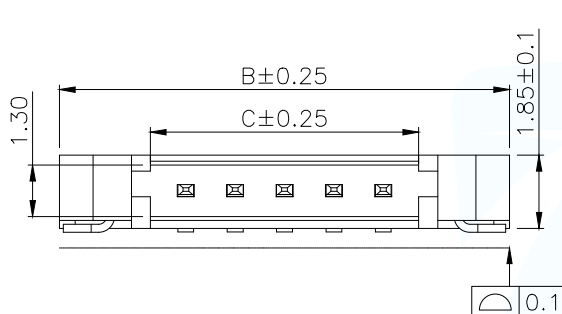
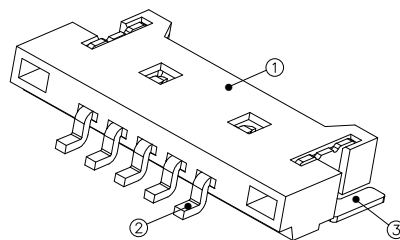
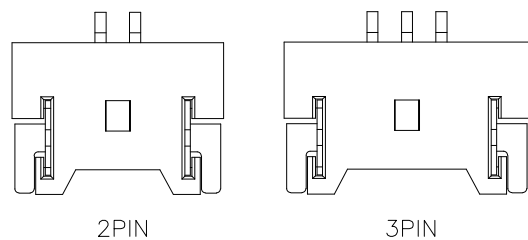




PCB LAYOUT

Part No	PIN	A	B	C
WAFER-MX1.25-2PCB	2	1.25	7.65	3.05
WAFER-MX1.25-3PCB	3	2.50	8.90	4.30
WAFER-MX1.25-4PCB	4	3.75	10.15	5.55
WAFER-MX1.25-5PCB	5	5.00	11.40	6.80
WAFER-MX1.25-6PCB	6	6.25	12.65	8.05
WAFER-MX1.25-7PCB	7	7.50	13.90	9.30
WAFER-MX1.25-8PCB	8	8.75	15.15	10.55
WAFER-MX1.25-9PCB	9	10.00	16.40	11.80
WAFER-MX1.25-10PCB	10	11.25	17.65	13.05
WAFER-MX1.25-11PCB	11	12.50	18.90	14.30
WAFER-MX1.25-12PCB	12	13.75	20.15	15.55
WAFER-MX1.25-13PCB	13	15.00	21.40	16.80
WAFER-MX1.25-14PCB	14	16.25	22.65	18.05
WAFER-MX1.25-15PCB	15	17.50	23.90	19.30
WAFER-MX1.25-16PCB	16	18.75	25.15	20.55

NOTES:

- 1.BASE: PA6T
- 2.PIN: Brass
- 3.Solder Tab: Brass

SPECIFICATIONS:

- 1.Spacing: 1.25
- 2.Voltage Rating: 125V AC DC
- 3.Current Rating: 1A AC DC
- 4.Insulation Resistance: 100MΩ Min
- 5.Contact Resistance: 20mΩ Max
- 6.Withstanding voltage: 500V AC 1/Minute
- 7.Temperatuer Range: $-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: WAFER 1.25 超薄
			PAR WAFER-MX1.25-NPCB
DECIMALS:	ANGLES:		DWN
X.:±0.2	X':.:±5°		CHKD
.X:±0.1	X.X':.:±3°		APVD
.XX:±0.05	X.XX':.:±1°		SCALE:1:1 UNIT:MM
CUSTOMER COPY		SIZE:A4	SHEET:1F1
			REV:A